

# LTC1731-8.2/LTC1731-8.4

### Lithium-Ion Linear Battery Charger Controller

### FEATURES

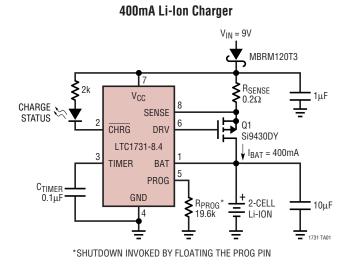
- Complete Linear Charger Controller for 2-Cell Lithium-Ion Batteries
- 1% Voltage Accuracy
- Programmable Charge Current
- C/10 Charge Current Detection Output
- Programmable Charge Termination Timer
- Space Saving 8-Pin MSOP Package
- Automatic Sleep Mode When Input Supply is Removed (15µA Battery Drain)
- Automatic Trickle Charging of Low Voltage Cells
- Programmable for Constant-Current-Only Mode

### **APPLICATIONS**

- Cellular Phones
- Handheld Computers
- Charging Docks and Cradles
- Programmable Current Source

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### TYPICAL APPLICATION

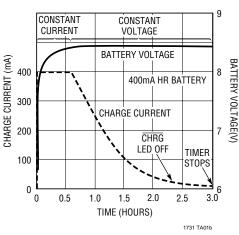


### DESCRIPTION

The LTC<sup>®</sup>1731-8.2/LTC1731-8.4 are complete constantcurrent/constant-voltage linear charger controllers for 2cell lithium-ion (Li-Ion)batteries. Nickel-cadmium (NiCd) and nickel-metal-hydride (NiMH) batteries can also be charged with constant current using external termination. The external sense resistor sets the charge current with 7% accuracy. An internal resistor divider and precision reference set the final float potential with 1% accuracy. The output float voltages are set internally to 8.2V (LTC1731-8.2) or 8.4V (LTC1731-8.4).

When the input supply is removed, the LTC1731-8.2/ LTC1731-8.4 automatically enter a low current sleep mode, dropping the battery drain current to typically  $15\mu$ A. An internal comparator detects the end-of-charge (**C**/10) condition while a programmable timer, using an external capacitor, sets the total charge time. Fully discharged cells are automatically trickle charged at 10% of the programmed current until battery voltage exceeds 4.95V.

The LTC1731-8.2/LTC1731-8.4 are available in the 8-pin MSOP and SO packages. For 1-cell Li-Ion battery charging, see the LTC1731-4.1 and LTC1731-4.2 data sheets.



#### **Typical Li-Ion Charge Cycle**



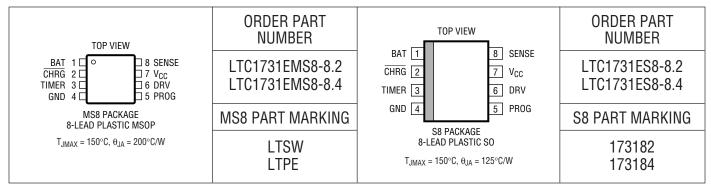
# LTC1731-8.2/LTC1731-8.4

#### ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage (V <sub>CC</sub> )	13.2V
SENSE, DRV, BAT, TIMER, PROG	-0.3V to V <sub>CC</sub>
CHRGC	.3V to 13.2V

Operating Temperature Range (Note 2)  $\dots -40^{\circ}$  to  $85^{\circ}$ C Storage Temperature Range  $\dots -65^{\circ}$ C to  $150^{\circ}$ C Lead Temperature (Soldering, 10 sec)  $\dots 300^{\circ}$ C

### PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

### **ELECTRICAL CHARACTERISTICS** The • denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $V_{CC} = 9V$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V <sub>CC</sub>	Input Supply Voltage			8.8		12	V
I <sub>CC</sub>	Input Supply Current	Charger On, Current Mode Shutdown Mode Sleep Mode (Battery Drain Current)	•		1 1 15	3 2 30	mA mA μA
V <sub>BAT</sub>	Regulated Output Voltage	LTC1731-8.2 (9V $\leq$ V <sub>CC</sub> $\leq$ 12V) LTC1731-8.4 (9V $\leq$ V <sub>CC</sub> $\leq$ 12V)	•	8.118 8.316	8.2 8.4	8.282 8.484	V V
I <sub>BAT</sub>	Current Mode Charge Current	$\begin{array}{l} R_{PROG} = 19.6k,  R_{SENSE} = 0.2\Omega \\ R_{PROG} = 19.6k,  R_{SENSE} = 0.2\Omega \\ R_{PROG} = 97.6k,  R_{SENSE} = 0.2\Omega \end{array}$	•	465 415 70	500 500 100	535 585 130	mA mA mA
I <sub>TRIKL</sub>	Trickle Charge Current	$V_{BAT} = 4V, R_{PROG} = 19.6k, I_{TRIKL} = (V_{CC} - V_{SENSE})/0.2\Omega$		30	50	100	mA
V <sub>TRIKL</sub>	Trickle Charge Threshold Voltage	BAT Rising		4.7	4.95	5.1	V
V <sub>UV</sub>	V <sub>CC</sub> Undervoltage Lockout Voltage	V <sub>CC</sub> Rising			8.2	8.8	V
$\Delta V_{UV}$	V <sub>CC</sub> Undervoltage Lockout Hysteresis	V <sub>CC</sub> Falling			200		mV
V <sub>MSD</sub>	Manual Shutdown Threshold Voltage	PROG Pin Rising PROG Pin Falling			2.457 2.446		V V
I <sub>DRV</sub>	Drive Pin Current	$V_{DRV} = V_{CC} - 2V$			26		μA

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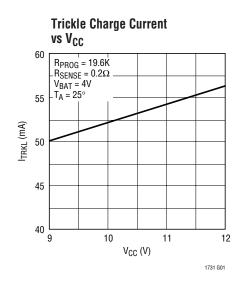
**ELECTRICAL CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. V<sub>CC</sub> = 9V unless otherwise noted.

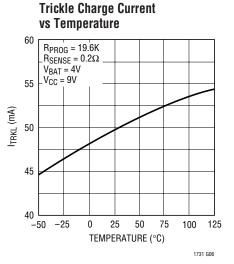
SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
V <sub>ASD</sub>	Automatic Shutdown Threshold Voltage	$(V_{CC} - V_{BAT})$ Falling $(V_{CC} - V_{BAT})$ Rising		30 40	54 69	90 100	mV mV
V <sub>DIS</sub>	Voltage Mode Disable Threshold Voltage	$V_{DIS} = (V_{CC} - V_{TIMER})$	•			0.4	V
I <sub>PROG</sub>	PROG Pin Current	Internal Pull-Up Current, No R <sub>PROG</sub>			2.5		μA
	PROG Pin Load Regulation	PROG Pin Source Current, $\Delta V_{PROG} \le 5mV$	•	300			μA
V <sub>PROG</sub>	PROG Pin Voltage	R <sub>PROG</sub> =19.6k			2.457		V
I <sub>CHRG</sub>	CHRG Pin Weak Pull-Down Current	V <sub>CHRG</sub> = 1V		50	100	150	μA
V <sub>CHRG</sub>	CHRG Pin Output Low Voltage	I <sub>CHRG</sub> = 5mA			0.6	1.2	V
I <sub>C/10</sub>	End of Charge Indication Current Level	$R_{PROG} = 19.6k, R_{SENSE} = 0.2\Omega$	•	25	50	100	mA
t <sub>TIMER</sub>	TIMER Accuracy	$C_{TIMER} = 0.01 \mu F$			10		%
V <sub>CLAMP</sub>	DRV Pin Clamp Voltage	$V_{CLAMP} = V_{CC} - V_{DRV}$ , $I_{DRIVE} = 50 \mu A$			6.5		V

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

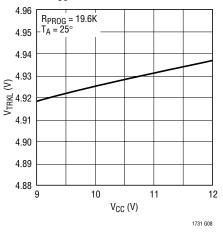
Note 2: The LTC1731E-8.2/LTC1731E-8.4 are guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls. Consult factory for I grade parts.

### TYPICAL PERFORMANCE CHARACTERISTICS

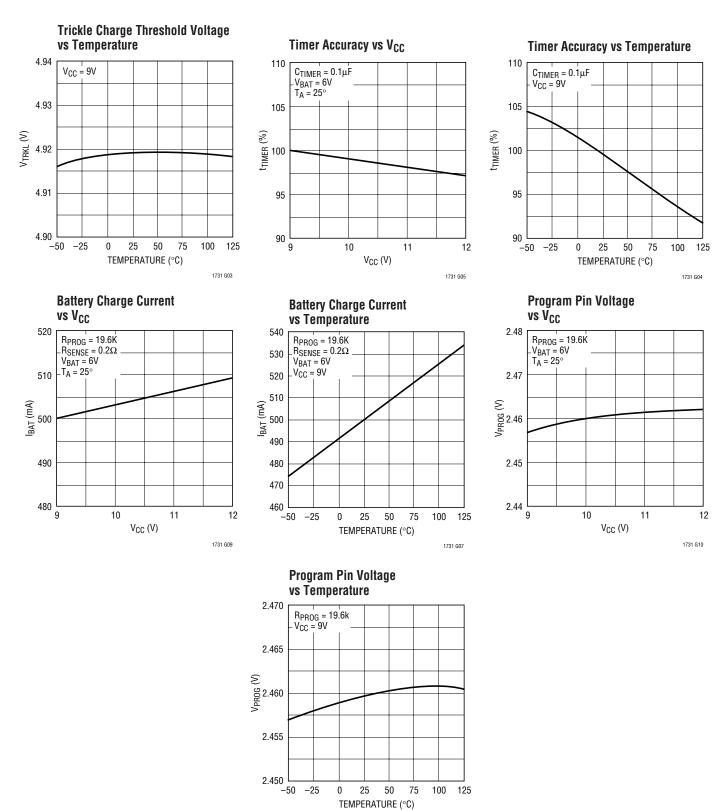




#### **Trickle Charge Threshold Voltage** vs V<sub>CC</sub>



### **TYPICAL PERFORMANCE CHARACTERISTICS**



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#### PIN FUNCTIONS

**BAT (Pin 1):** Battery Sense Input. A bypass capacitor of at least  $10\mu$ F is required to keep the loop stable when the battery is not connected. A precision internal resistive divider sets the final float potential on this pin. The resistor divider is disconnected in sleep mode.

**CHRG** (Pin 2): Open-Drain Charge Status Output. When the battery is being charged, the CHRG pin is pulled low by an internal N-channel MOSFET. When the charge current drops to 10% of the full-scale current for at least 0.32 seconds, the N-channel MOSFET turns off and a 100 $\mu$ A current source is connected from the CHRG pin to GND. When the timer runs out or the input supply is removed, the current source will be disconnected and the CHRG pin is forced into a high impedance state.

**TIMER (Pin 3):** Timer Capacitor and Constant-Voltage Mode Disable Input Pin. A capacitor  $C_{TIMER}$  connected from this pin to ground sets a 30 hour/ $\mu$ F time period for charge termination. When the TIMER pin is connected to V<sub>CC</sub>, the constant-voltage mode and the timer is disabled and the IC will operate in constant-current mode only. Short the TIMER pin to GND to disable the internal timer and the **C**/10 functions. GND (Pin 4): Ground.

**PROG (Pin 5):** Charge Current Program and Shutdown Input Pin. The charge current is programmed by connecting a resistor,  $R_{PROG}$  to ground. The charge current is  $I_{BAT} = (V_{PROG} \cdot 800\Omega)/(R_{PROG} \cdot R_{SENSE})$ . The IC can be forced into shutdown by floating the PROG pin and allowing the internal 2.5µA current source to pull the pin above the 2.457V shutdown threshold voltage.

**DRV (Pin 6):** Drive Output Pin for the P-Channel MOSFET or PNP Transistor. If a PNP transistor is used, it must have high gain (see Applications Information section). The DRV pin is internally clamped to 6.5V below V<sub>CC</sub>.

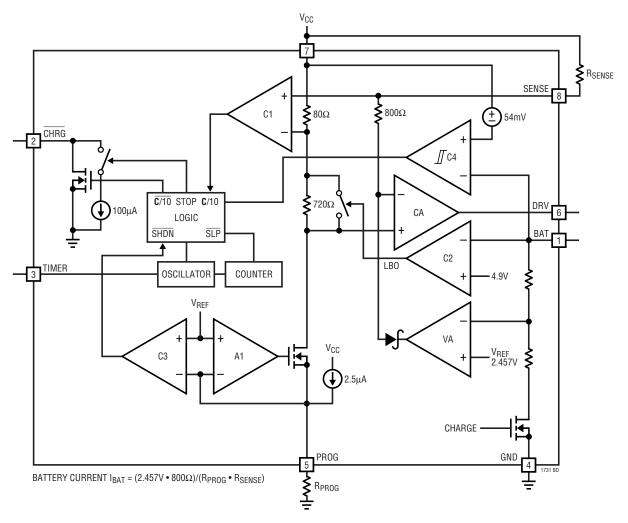
**V<sub>CC</sub> (Pin 7):** Input Supply Voltage. V<sub>CC</sub> ranges from 8.8V to 12V when charging. If V<sub>CC</sub> drops below V<sub>BAT</sub> + 54mV, for example when the input supply is disconnected, then the IC enters sleep mode with I<sub>CC</sub> < 30 $\mu$ A. Bypass this pin with a 1 $\mu$ F capacitor.

**SENSE (Pin 8):** Current Sense Input. Connect this pin to the sense resistor. Choose the resistor value using the following equation:

 $R_{SENSE} = (V_{PROG} \bullet 800\Omega)/(R_{PROG} \bullet I_{BAT})$ 



# **BLOCK DIAGRAM**







### OPERATION

The LTC1731-8.2/LTC1731-8.4 are linear battery charger controllers. The charge current is programmed by the combination of a program resistor ( $R_{PROG}$ ) from the PROG pin to ground and a sense resistor ( $R_{SENSE}$ ) between the V<sub>CC</sub> and SENSE pins.  $R_{PROG}$  sets a program current through an internal trimmed 800 $\Omega$  resistor that creates a voltage drop from V<sub>CC</sub> to the input of the current amplifier (CA). The current amplifier servos the gate of the external P-channel MOSFET to force the same voltage drop across  $R_{SENSE}$  which sets the charge current. When the potential at the BAT pin approaches the preset float voltage, the voltage amplifier (VA) will start sinking current which shrinks the voltage drop across  $R_{SENSE}$ , thus reducing the charge current.

Charging begins when the potential at  $V_{CC}$  pin rises above the UVLO level and a program resistor is connected from the PROG pin to ground. At the beginning of the charge cycle, if the battery voltage is below 4.95V, the charger goes into trickle charge mode. The trickle charge current is 10% of the full-scale current. If the cell voltage stays low for one quarter of the total charge time, the charge sequence will terminate.

The charger goes into the fast charge constant-current mode after the voltage on the BAT pin rises above 4.95V. In constant-current mode, the charge current is set by the combination of  $R_{SENSE}$  and  $R_{PROG}$ .

When the battery approaches the final float voltage, the charge current will begin to decrease. When the current drops to 10% of the full-scale charge current, an internal comparator will turn off the N-channel MOSFET at the CHRG pin and connect a weak current source to ground to indicate a near end-of-charge (C/10) condition.

An external capacitor on the TIMER pin sets the total charge time. After a time-out occurs, the charge cycle is terminated and the CHRG pin is forced to a high impedance state. To restart the charge cycle, simply remove the input voltage and reapply it, or float the PROG pin momentarily.

For batteries like lithium-ion that require an accurate final float potential, the internal 2.457V reference, voltage amplifier and the resistor divider provide regulation with  $\pm$ 1% (max) accuracy. For NiMH and NiCd batteries, the LTC1731-8.2/LTC1731-8.4 can be turned into a current source by pulling the TIMER pin to V<sub>CC</sub>. When in the constant-current only mode, the voltage amplifier, timer and the trickle charge function are all disabled.

The charger can be shut down by floating the PROG pin  $(I_{CC} \approx 1 mA)$ . An internal current source will pull it high and clamp at 3.5V.

When the input voltage is not present, the charger goes into a sleep mode, dropping  $I_{CC}$  to  $15\mu$ A. This greatly reduces the current drain on the battery and increases the standby time.



### **APPLICATIONS INFORMATION**

#### **Charger Conditions**

The charger is off when any of the following conditions exist: the V<sub>CC</sub> pin is less than 8.2V, the droput voltage (V<sub>CC</sub> - V<sub>BAT</sub>) is less than 54mV, the PROG pin is floating, or the timer has ended. The DRV pin will be pulled to V<sub>CC</sub> and the internal resistor divider is disconnected to reduce the current drain on the battery.

#### Undervoltage Lockout (UVLO)

An internal undervoltage lockout circuit monitors the input voltage and keeps the charger in shutdown mode until V<sub>CC</sub> rises above 8.2V. To prevent oscillation around V<sub>CC</sub> = 8.2V, the UVLO circuit has built-in hysteresis.

#### Trickle Charge and Defective Battery Detection

At the beginning of the charging sequence, if the battery voltage is less than 4.95V the charger goes into trickle charge mode. The charge current is reduced to 10% of the full-scale current. If the low battery voltage persists for one quarter of the total charging time, the battery is considered defective, charging will be terminated and the CHRG pin output is forced to a high impedance state.

#### Shutdown

The LTC1731-8.2/LTC1731-8.4 can be forced into shutdown by floating the PROG pin and allowing the internal  $2.5\mu$ A current source to pull the pin above the 2.457V shutdown threshold voltage. The DRV pin is then pulled up to V<sub>CC</sub> turning off the external P-channel MOSFET. The internal timer is reset in the shutdown mode.

#### Programming Charge Current

The formula for the battery charge current (see Block Diagram) is:

 $I_{BAT} = (2.457 V/R_{PROG})(800 \Omega/R_{SENSE})$ 

where  $\mathsf{R}_{\mathsf{PROG}}$  is the total resistance from the PROG pin to ground.

For example, if 0.5A charge current is needed, select a value for  $R_{SENSE}$  that will drop 100mV at the maximum charge current.  $R_{SENSE} = 0.1V/0.5A = 0.2\Omega$ , then calculate:

 $R_{PR0G} = (2.457 V/500 mA)(800 \Omega/0.2 \Omega) = 19.656 k$ 

For best stability over temperature and time, 1% resistors are recommended. The closest 1% resistor value is 19.6k.

#### Programming the Timer

The programmable timer is used to terminate the charge. The length of the timer is programmed by an external capacitor at the TIMER pin. The total charge time is:

Time (Hours) =  $(3 \text{ Hours})(C_{TIMER}/0.1\mu F)$ 

The timer starts when the input voltage greater than 8.2V is applied and the program resistor is connected to ground. After a time-out occurs, the CHRG output will become high impedance indicating that the charge cycle has ended. Connecting the TIMER pin to  $V_{CC}$  disables the timer and also puts the charger into a constant-current mode. To only disable the timer function, short the TIMER pin to GND.

#### CHRG Status Output Pin

When the charge cycle starts, the  $\overline{CHRG}$  pin is pulled to ground by an internal N-channel MOSFET that can drive an LED. When the charge current drops to 10% of the fullscale current (C/10), the N-channel MOSFET turns off and a weak 100µA current source to ground is connected to the CHRG pin. After a time-out occurs, the CHRG pin goes high impedance indicating that the charge cycle has ended. By using two different value pull-up resistors, a microprocessor can detect three states from this pin (charging, C/10 and stop charging). See Figure 1.

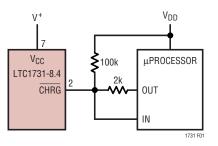


Figure 1. Microprocessor Interface

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### **APPLICATIONS INFORMATION**

When the LTC1731 is in the charge mode, the CHRG pin is pulled to ground by an internal N-channel MOSFET. To detect this mode, force the digital output pin, OUT, high and measure the voltage at the CHRG pin. The N-channel MOSFET will pull the pin low even with a 2k pull-up resistor. Once the charge current drops to 10% of the fullscale current (C/10), the N-channel MOSFET is <u>turned</u> off and a 100µA current source is connected to the CHRG pin. By forcing the OUT pin into a high impedance state, the current source will pull the pin low through the <u>100k</u> resistor. When the internal timer has expired, the CHRG pin will change to high impedance and the 100k resistor will then pull the pin high to indicate the charge cycle has ended.

#### End of Charge (C/10)

The LTC1731-8.2/LTC1731-8.4 include a comparator to monitor the charge current to detect a near end-of-charge condition. This comparator does not terminate the charge cycle, but provides and output signal to indicate a near full charge condition. The timer is used to terminate the charge cycle. When the battery current falls below 10% of full scale, the comparator trips and turns off the N-channel MOSFET at the CHRG pin and switches in a 100 $\mu$ A current source to ground. After an internal time delay of 320ms, this state is then latched. This delay will help prevent false triggering due to transient currents. The end-of-charge comparator is disabled in trickle charge mode.

#### **Gate Drive**

Typically the LTC1731-8.2/LTC1731-8.4 drive an external P-channel MOSFET to supply current to the battery. The DRV pin is internally clamped to 6.5V below  $V_{CC}$ . This feature allows low voltage P-channel MOSFETs with gate to source breakdown voltage rated at 8V to be used.

An external PNP transistor can also be used as the pass transistor instead of the P-channel MOSFET. Due to the low current gain of the current amplifier (CA), a high gain Darlington PNP transistor is required to avoid excessive charging current error. The gain of the current amplifier is around  $0.6\mu$ A/mV. For every  $1\mu$ A of base current, a 1.6mV gain error shows up at the inputs of CA. With R<sub>PROG</sub> = 19.6k and 100mV across R<sub>SENSE</sub>, this gain error causes a 1.67% error in charge current.

#### **Constant-Current Only Mode**

The LTC1731-8.2/LTC1731-8.4 can be used as a programmable current source by forcing the TIMER pin to  $V_{CC}$ . This is particularly useful for charging NiMH or NiCd batteries. In the constant-current only mode, the timer and voltage amplifier are both disabled. An external termination method is required to properly terminate the charge.

#### Stability

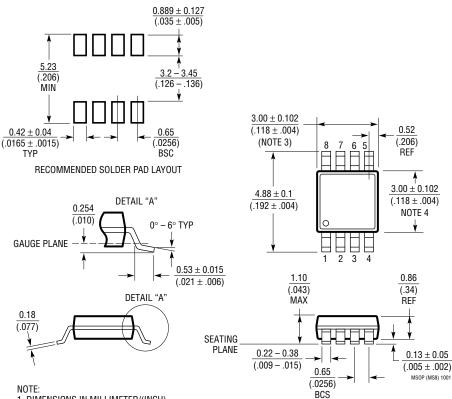
The charger is stable without any compensation when a P-channel MOSFET is used as the pass transistor. However, a  $10\mu$ F capacitor is recommended at the BAT pin to keep the ripple voltage low when the battery is disconnected. A ceramic output capacitor may also be used, but because of the very low ESR and high Q characteristics of multilayer ceramic capacitors, it may be necessary to add a  $1\Omega$  resistor in series with the ceramic capacitor to improve voltage mode stability.

When a PNP transistor is chosen as the pass transistor, a 1000pF capacitor is required from the DRV pin to  $V_{CC}$ . This capacitor is needed to help stablize the voltage loop. A 10µF capacitor at the BAT pin is also recommended when a battery is not present.



### PACKAGE DESCRIPTION

**MS8** Package 8-Lead Plastic MSOP (Reference LTC DWG # 05-08-1660)



1. DIMENSIONS IN MILLIMETER/(INCH)

2. DRAWING NOT TO SCALE

3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE 4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.

INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE

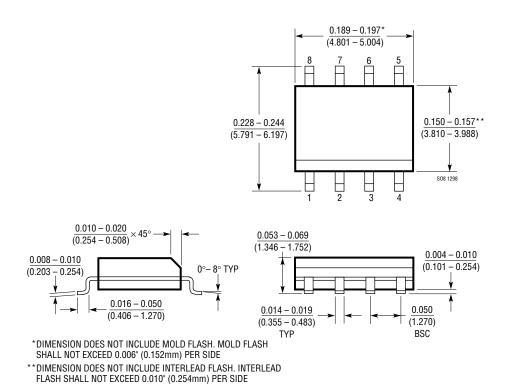
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX





#### PACKAGE DESCRIPTION

S8 Package 8-Lead Plastic Small Outline (Narrow .150 Inch) (Reference LTC DWG # 05-08-1610)



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